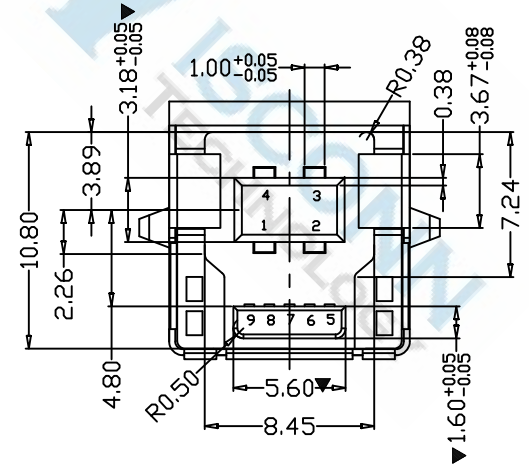


PCB LAYOUT

Pin NUMBER	SIGNAL NAME
1	VBUS
2	D-
3	D+
4	GND
5	StdB_SSTX-
6	StdB_SSTX+
7	GND_DRAIN
8	StdB_SSRX-
9	StdB_SSRX+
Shell	Shield

NOTE:

- MATERIAL:
 - INSULATOR:LCP UL 94V-0
 - CONTACT:1-4Pin, COPPER (T=0.20mm)
5-9Pin, BRASS (T=0.20mm)
 - SHELL:BRASS (T=0.30mm)
- ELECTRICAL CHARACTERISTICS:
 - CONTACT RESISTANCE:30mΩ MAXIMUM
 - CONTACT CURRENT RATING:1.5A
 - DIELECTRIC WITHSTANDING VOLTAGE:
500 V R. M. S.
 - INSULATION RESISTANCE 1000 MEGOHMS MIN
 - OPERATING TEMPERATURE:-40° C ~ 85° C
- MECHANICAL CHARACTERISTICS:
 - MATING FORCE:3.57kg MAX
 - UNMATING FORCE:1.02kg MIN
 - DURABILITY:MANDATORY:5,000 CYCLES
- PLATING
 - TERMINAL:50u" MIN NICKEL ALL OVER
80u"MIN Tin ON SOLDER AREA
(1~30)u"Au ON CONTACT AREA
 - SHELL:100u"MIN. NICEL
- PART NO :WU3BF-09xxLBUDV-8.5



DIMENSIONS TOLERANCE METRIC .0=±0.30 .00=±0.20 .000=±0.10 ANG.=±2°	單位(UNITS)	MM	處理(FINISH)	SEE NOTE	審校(CH'K)	Calvin	圖名(NAME)		WISCONN Technology Co., Ltd Tel:02-2742-1798 Fax:02-2742-1898					
	數量(QT'Y)	N/A	繪圖(DRAW)	Johnson	核准(APP'D)	Selena	USB3.0 B Female 180度 DIP							
	料號(PART NUMBER)	WU3BF-09xxLBUDV-8.5		圖號(DRAW NUMBER)	T002		比例(SCALE)	1/1	圖紙(SIZE)	A4	頁次(SHEET)	1	版次(REV.)	A
	材料(MT'L)	SEE NOTE	設計(DE'N)	Mike	日期 DATE)	OCT.15.2007	圖檔(FILE NAME .DWG)							